



March 2009

## FAN7081\_F085 High Side Gate Driver

# FAN7081\_F085 High Side Gate Driver

### Features

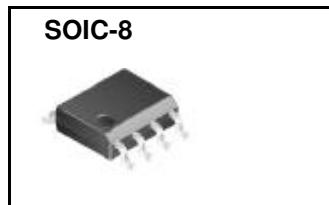
- Qualified to AEC Q100
- Floating channel designed for bootstrap operation up to + 600V
- Tolerance to negative transient voltage on VS pin
- dV/dt immune.
- Gate drive supply range from 10V to 20V
- Under-voltage lockout
- CMOS Schmitt-triggered inputs with pull-up
- High side output out of phase with input (Inverted input)

### Typical Applications

- Diesel and gasoline Injectors/Valves
- MOSFET-and IGBT high side driver applications

### Description

The FAN7081\_F085 is a high-side gate drive IC designed for high voltage and high speed driving of MOSFET or IGBT, which operates up to 600V. Fairchild's high-voltage process and common-mode noise cancellation technique provide stable operation in the high side driver under high-dV/dt noise circumstances. An advanced level-shift circuit allows high-side gate driver operation up to VS=-5V (typical) at VBS=15V. Logic input is compatible with standard CMOS outputs. The UVLO circuits prevent malfunction when VCC and VBS are lower than the specified threshold voltage. It is available with space saving SOIC-8 Package. Minimum source and sink current capability of output driver is 250mA and 500mA respectively, which is suitable for magnetic- and piezo type injectors and general MOSFET/IGBT based high side driver applications.

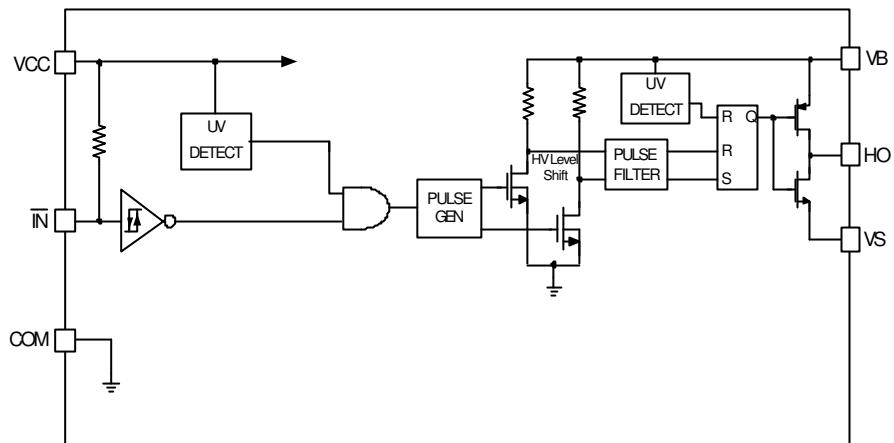


### Ordering Information

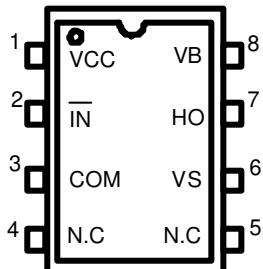
Device	Package	Operating Temp.
FAN7081CM	SOIC-8	-40 °C ~ 125 °C
FAN7081CMX	SOIC-8	-40 °C ~ 125 °C

X : Tape & Reel type

### Block Diagrams



### Pin Assignments



### Pin Definitions

Pin Number	Pin Name	I/O	Pin Function Description
1	VCC	P	Driver supply voltage
2	IN	I	Logic input for high side gate drive output, out of phase with HO
3	COM	P	Ground
4	NC	-	NC
5	NC	-	NC
6	VS	P	High side floating offset for MOSFET Source connection
7	HO	A	High side drive output for MOSFET Gate connection
8	VB	P	Driver output stage supply

## Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM.

Parameter	Symbol	Min.	Max.	Unit
High side floating supply offset voltage	V <sub>s</sub>	V <sub>B</sub> -25	V <sub>B</sub> +0.3	V
High side floating supply voltage	V <sub>B</sub>	-0.3	625	V
High side floating output voltage	V <sub>HO</sub>	V <sub>s</sub> -0.3	V <sub>B</sub> +0.3	V
Supply voltage	V <sub>CC</sub>	-0.3	25	V
Input voltage for I <sub>N</sub>	V <sub>IN</sub>	-0.3	V <sub>CC</sub> +0.3	V
Power Dissipation <sup>1)</sup>	P <sub>d</sub>		0.625	W
Thermal resistance, junction to ambient <sup>1)</sup>	R <sub>thja</sub>		200	°C/W
Electrostatic discharge voltage (Human Body Model)	V <sub>ESD</sub>	1K		V
Charge device model	V <sub>CDM</sub>	500		V
Junction Temperature	T <sub>j</sub>		150	°C
Storage Temperature	T <sub>S</sub>	-55	150	°C

Note: 1) The thermal resistance and power dissipation rating are measured below conditions;

JESD51-2: Integrated Circuit Thermal Test Method Environmental Conditions - Natural condition(StillAir)

JESD51-3: Low Effective Thermal Conductivity Test Board for Leaded Surface Mount Package

## Recommended Operating Conditions

For proper operations the device should be used within the recommended conditions. -40°C <= T<sub>a</sub> <= 125°C

Parameter	Symbol	Min.	Max.	Unit
High side floating supply voltage(DC) Transient:-10V@ 0.2 us	V <sub>B</sub>	V <sub>s</sub> + 10	V <sub>s</sub> + 20	V
High side floating supply offset voltage(DC)	V <sub>s</sub>	-5	600	V
High side floating supply offset voltage(Transient)	V <sub>s</sub>	-25 (~200ns) -20(200ns ~240ns) -7(240ns~400ns)	600	V
High side floating output voltage	V <sub>HO</sub>	V <sub>s</sub>	V <sub>B</sub>	V
Allowable offset voltage Slew Rate <sup>1)</sup>	dV/dt	-	50	V/ns
Supply voltage	V <sub>CC</sub>	10	20	V
Input voltage for I <sub>N</sub>	V <sub>IN</sub>	0	V <sub>CC</sub>	V
Switching Frequency <sup>2)</sup>	F <sub>s</sub>		200	KHz
Ambient Temperature	T <sub>a</sub>	-40	125	°C

Note: 1) Guaranteed by design.

2) Duty = 0.5

### Statics Electrical Characteristics

Unless otherwise specified,  $-40^{\circ}\text{C} \leq \text{Ta} \leq 125^{\circ}\text{C}$ ,  $\text{VCC} = 15\text{V}$ ,  $\text{VBS} = 15\text{V}$ ,  $\text{VS} = 0\text{V}$ ,  $\text{RL} = 50\Omega$ ,  $\text{CL} = 2.5\text{nF}$ .

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Vcc and VBS supply Characteristics</b>						
Vcc and VBS supply under voltage positive going threshold	VCCUV+ VBSUV+		-	8.7	9.8	V
Vcc and VBS supply under voltage negative going threshold	VCCUV- VBSUV-		7.4	8.2	-	V
Vcc and VBS supply under voltage hysteresis	VCCUVH VBSUVH	-	0.2	0.5	-	V
Under voltage lockout response time	tduvcc tduvbs	VCC: 10V-->7.3V or 7.3V-->10V VBS: 10V-->7.3V or 7.3V-->10V	0.5 0.5		20 20	us us
Offset supply leakage current	ILK	$\text{VB}=\text{VS}=600\text{V}$	-	-	50	uA
Quiescent VBS supply current	IQBS	$\text{VIN}=0$	-	23	250	uA
Quiescent Vcc supply current	IQCC1	$\text{VIN}=0\text{V}$	-	42	120	uA
Quiescent Vcc supply current	IQCC2	$\text{VIN}=15\text{V}$	-	25	100	uA
<b>Input Characteristics</b>						
High logic level input voltage	VIH		0.6VCC	-	-	V
Low logic level input voltage	VIL		-	-	0.4VCC	V
Low logic level input bias current for IN	IIN+	$\text{VIN}=0$	-	15	50	uA
High logic level input bias current for IN	IIN-	$\text{VIN}=15\text{V}$	-	0	1	uA
<b>Output characteristics</b>						
High level output voltage, $\text{VBIAS}-\text{VO}$	VOH	$\text{IO}=0$	-	-	0.1	V
Low level output voltage, VO	VOL	$\text{IO}=0$	-	-	0.1	V
Peak output source current	IO1+		250	-	-	mA
Peak output sink current	IO1-		500	-	-	mA
Equivalent output resistance	ROP			40	60	$\Omega$
	RON			20	30	$\Omega$

Note: The input parameter are referenced to COM. The VO and IO parameters are referenced to COM.

### Dynamic Electrical Characteristics

Unless otherwise specified, -40°C <= Ta <= 125°C, V<sub>CC</sub> = 15V, V<sub>BS</sub> = 15V, V<sub>S</sub> = 0V, R<sub>L</sub> = 50Ω, C<sub>L</sub> = 2.5nF.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Input-to-output turn-on propagation delay	t <sub>plh</sub>	50% input level to 10% output level, V <sub>S</sub> = 0V		130	300	ns
Input-to-output turn-off propagation delay	t <sub>phl</sub>	50% input level to 90% output level V <sub>S</sub> = 0V	-	140	300	ns
Output rising time	tr1	10% to 90%, T <sub>j</sub> =25°C, V <sub>BS</sub> =15V	-	15	400	ns
	tr2	10% to 90%		-	500	ns
Output falling time	tf1	90% to 10%, T <sub>j</sub> =25°C, V <sub>BS</sub> =15V	-	10	150	ns
	tf2	90% to 10%		-	500	ns

## **Application Information**

### **1. Relationship in input/output and supplies**

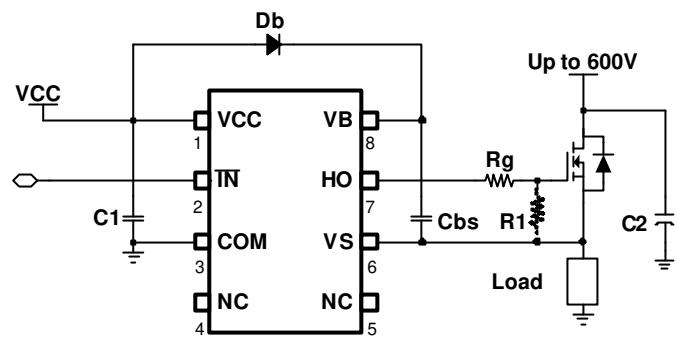
Table.1 Truth table for Vcc, VBS,VIN, and VHO

<b>VCC</b>	<b>VBS</b>	<b>IN</b>	<b>HO</b>
< VCCUVLO-	X	X	OFF
X	< VBSUVLO-	X	OFF
X	X	HIGH	OFF
> VCCUVLO+	> VBSUVLO+	LOW	ON

Notes:

X means independent from signal

Typical Application Circuit



## Typical Waveforms

### 1. Input/Output Timing

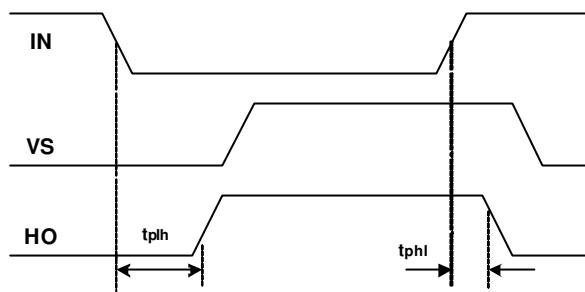


Figure 1. Input /output Timing Diagram

### 2. Output(HO) Switching Timing

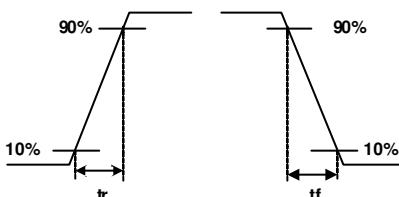


Figure 2. Switching Time Waveform Definitions

### 3.VB Drop Voltage Diagram

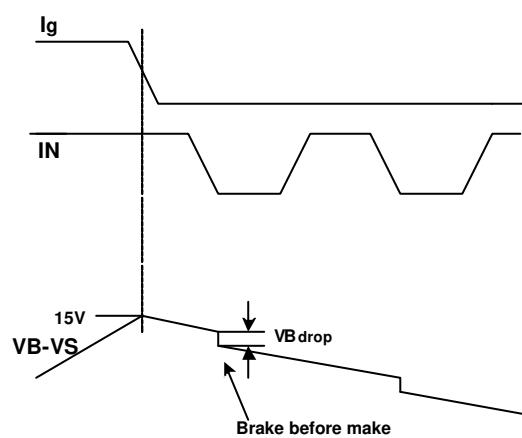


Figure 3a. VB Drop Voltage Diagram

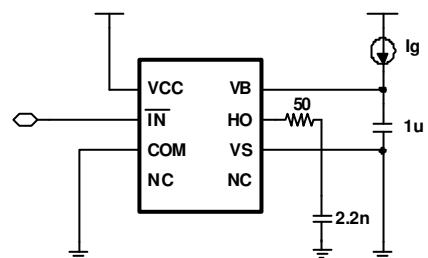


Figure3b. VB Drop Voltage Test Circuit

## Performance Graphs

This performance graphs based on ambient temperature -40°C ~125°C

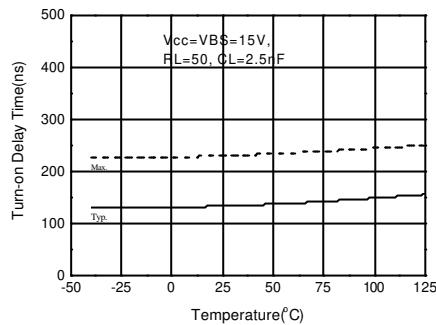


Figure 4a. Turn-On Delay Time vs Temperature

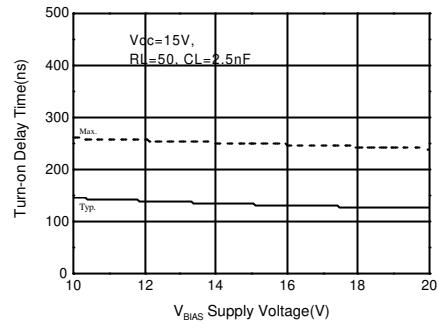


Figure 4b. Turn-On Delay Time vs VBS Supply Voltage

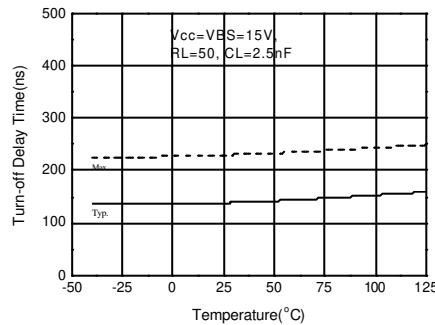


Figure 5a. Turn-Off Delay Time vs Temperature

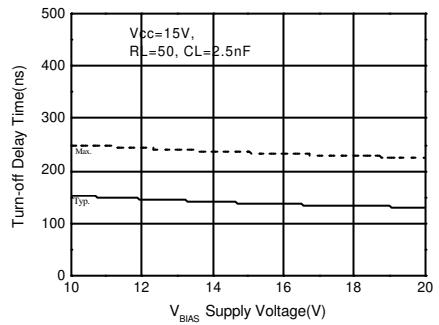


Figure 5b. Turn-Off Delay Time vs VBS Supply Voltage

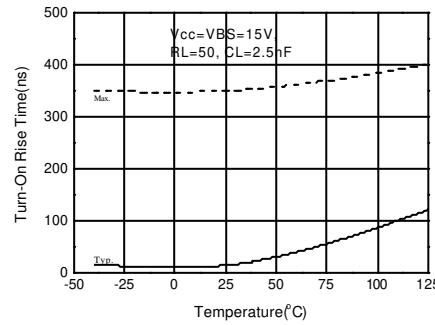


Figure 6a. Turn-On Rising Time vs Temperature

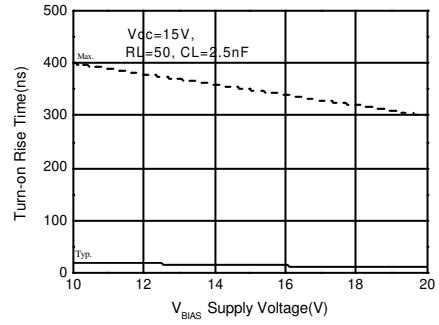


Figure 6b. Turn-ON Rising Time vs VBS Supply Voltage

## FAN7081\_F085 High Side Gate Driver

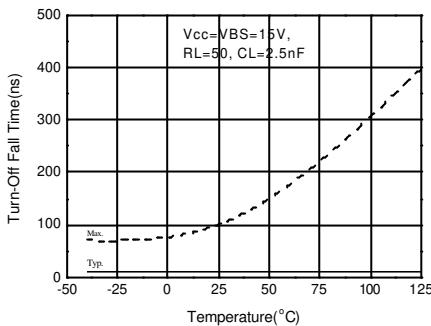


Figure 7a. Turn-Off Falling Time vs Temperature

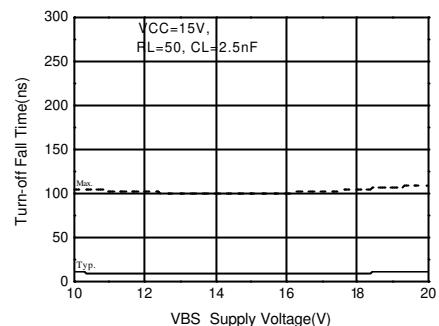


Figure 7b. Turn-Off Falling Time vs VBS Supply Voltage

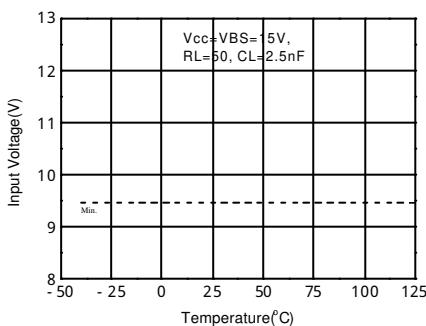


Figure 8a. Logic "1" IN Voltage vs Temperature

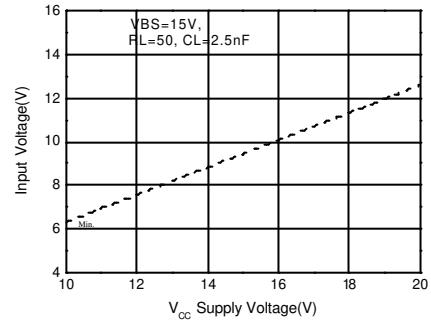


Figure 8b. Logic "1" IN Voltage vs VCC Supply Voltage

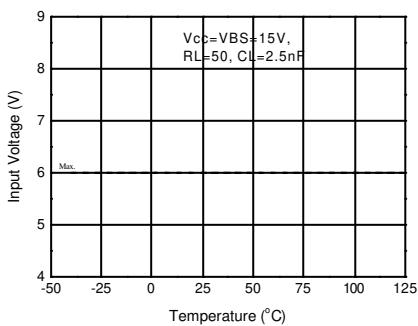


Figure 9a. Logic "0" IN Voltage vs Temperature

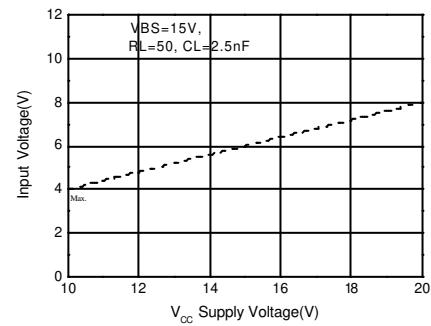
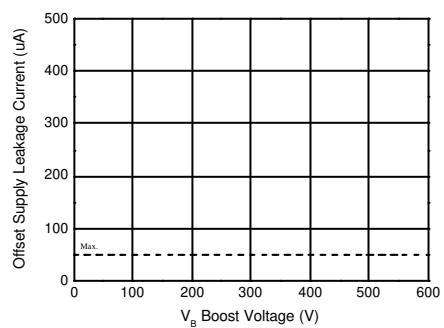
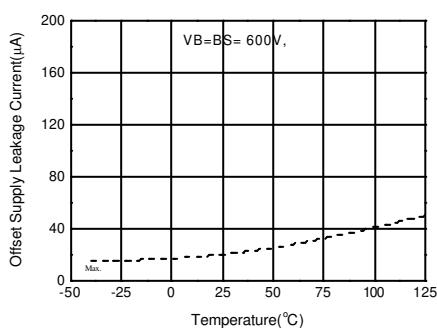
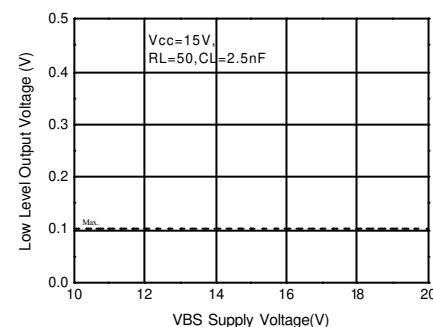
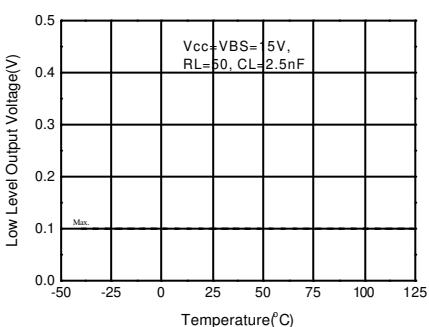
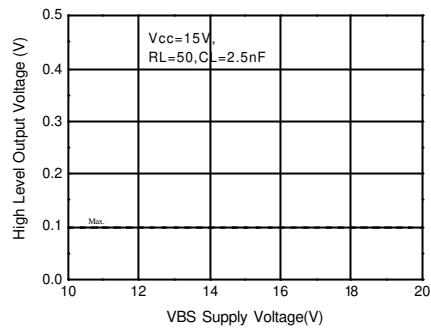
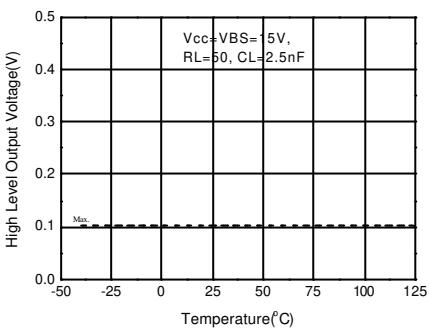


Figure 9b. Logic "0" IN Voltage vs VCC Supply Voltage

## FAN7081\_F085 High Side Gate Driver



## FAN7081\_F085 High Side Gate Driver

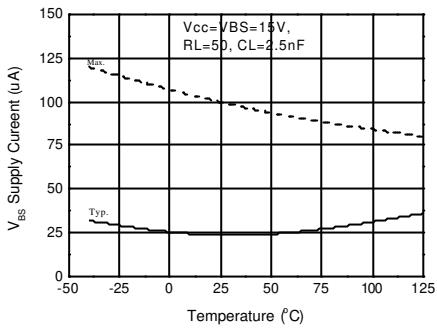


Figure 13a. VBS Supply Current vs Temperature

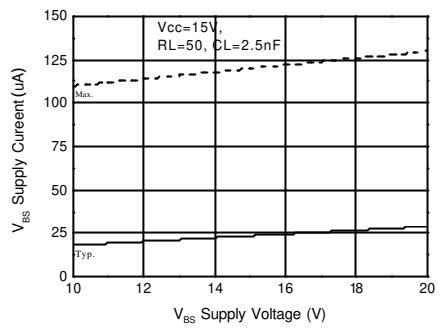


Figure 13b. VBS Supply Current vs VBS Supply Voltage

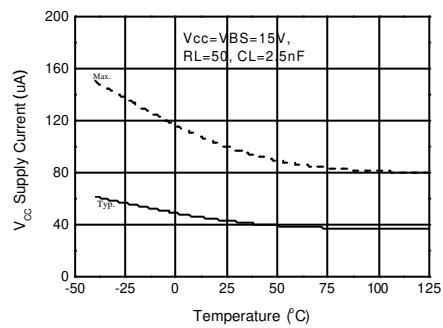


Figure 14a. VCC Supply Current vs Temperature

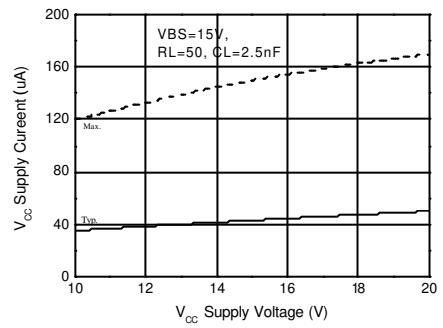


Figure 14b. VCC Supply Current vs VCC Supply Voltage

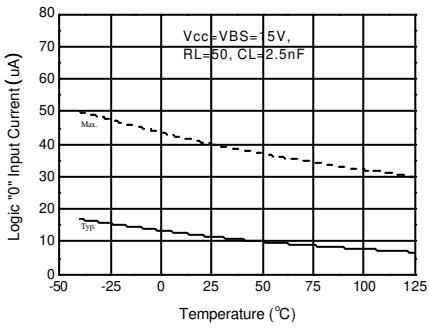


Figure 15a. Logic "0" IN Current vs Temperature

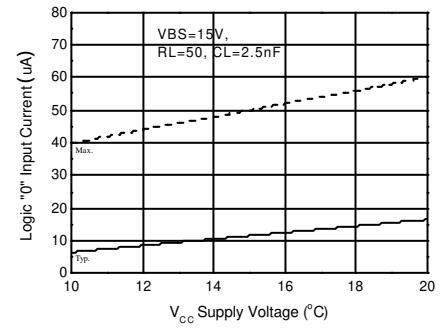
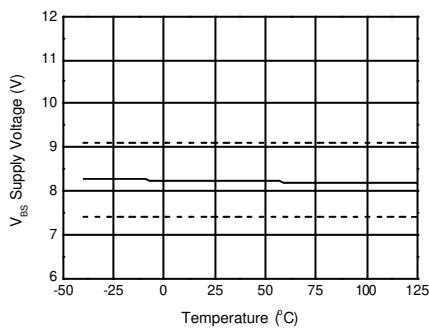
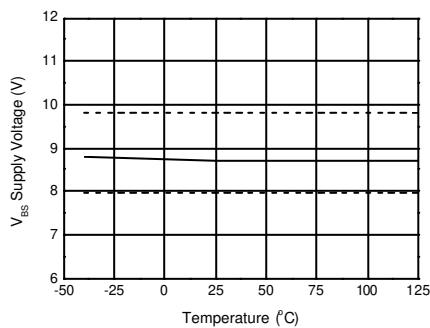
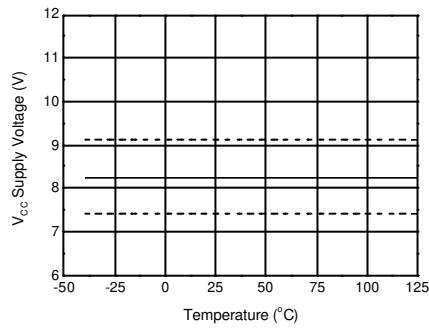
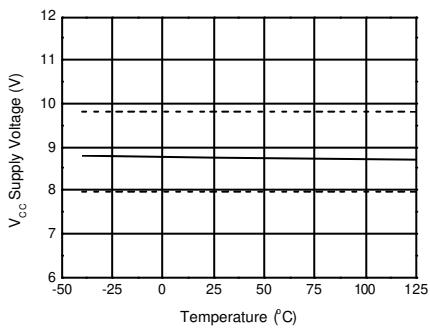
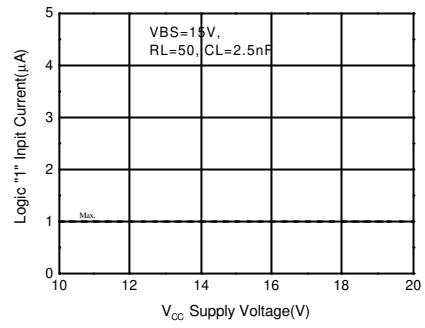
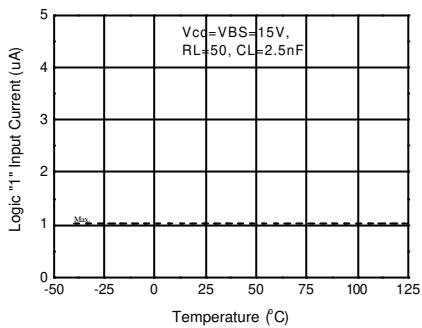
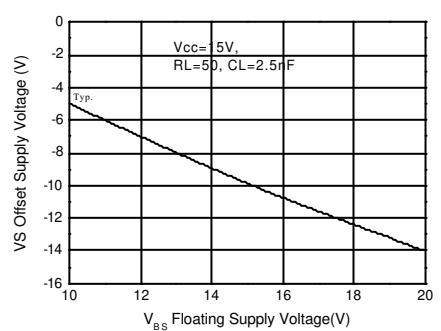
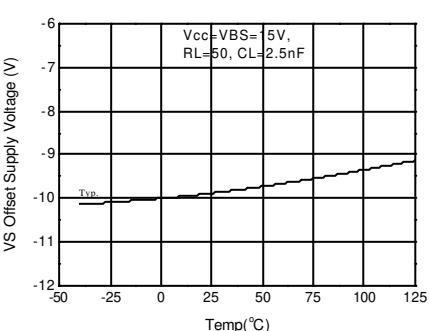
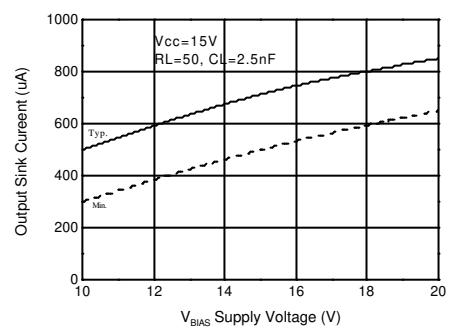
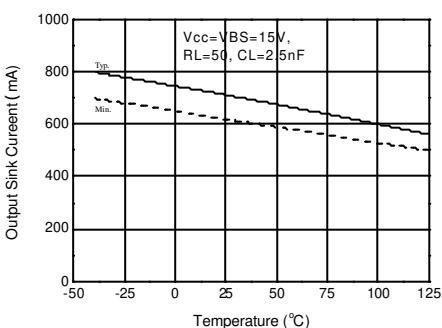
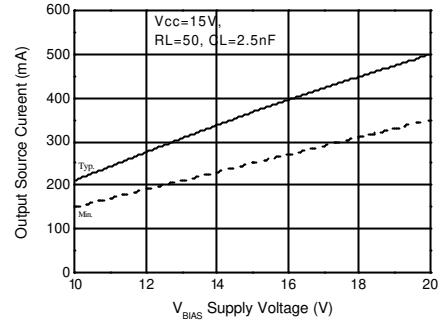
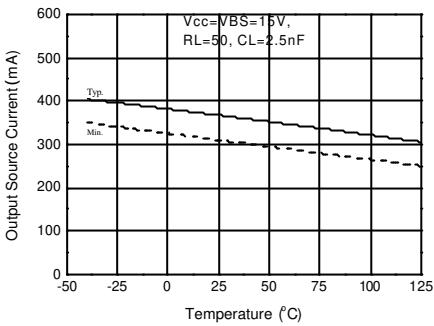


Figure 15b. Logic "0" IN Current vs VCC Supply Voltage

## FAN7081\_F085 High Side Gate Driver



## FAN7081\_F085 High Side Gate Driver



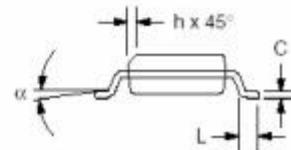
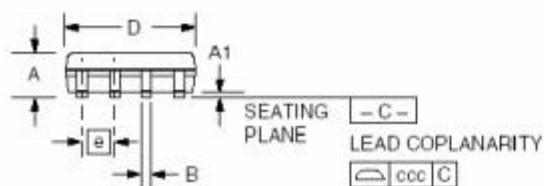
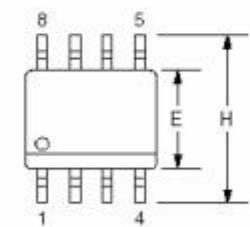
## Package Dimensions

## 8-SOP

Symbol	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	.053	.069	1.35	1.75	
A1	.004	.010	0.10	0.25	
B	.013	.020	0.33	0.51	
C	.0075	.010	0.20	0.25	5
D	.189	.197	4.80	5.00	2
E	.150	.158	3.81	4.01	2
φ	.050 BSC		1.27 BSC		
H	.228	.244	5.79	6.20	
h	.010	.020	0.25	0.50	
L	.016	.050	0.40	1.27	3
N	8		8		6
α	0°	8°	0°	8°	
ccc	—	.004	—	0.10	

## Notes:

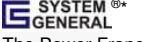
- Dimensioning and tolerancing per ANSI Y14.5M-1982.
- "D" and "E" do not include mold flash. Mold flash or protrusions shall not exceed .010 inch (0.25mm).
- "L" is the length of terminal for soldering to a substrate.
- Terminal numbers are shown for reference only.
- "C" dimension does not include solder finish thickness.
- Symbol "N" is the maximum number of terminals.





## TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

Build it Now™	FRFET®	Programmable Active Droop™	the <b>p</b> ower franchise
CorePLUS™	Global Power Resource™ <sup>SM</sup>	QFET®	TinyBoost™
CorePOWER™	Green FPS™	QS™	TinyBuck™
CROSSVOLT™	Green FPS™ e-Series™	Quiet Series™	TinyLogic®
CTL™	GTO™	RapidConfigure™	TINYOPTO™
Current Transfer Logic™	IntelliMAX™	 ™	TinyPower™
EcoSPARK®	ISOPLANAR™	Saving our world, 1mW/W/kW at a time™	TinyPWM™
EfficientMax™	MegaBuck™	SmartMax™	TinyWire™
EZSWITCH™*	MICROCOUPLER™	SMART START™	TriFault Detect™
 ™*	MicroFET™	SPM®	TRUECURRENT™*
 ®	MicroPak™	STEALTH™	μSerDes™
Fairchild®	MillerDrive™	SuperFET™	 SerDes™
Fairchild Semiconductor®	MotionMax™	SuperSOT™-3	UHC®
FACT Quiet Series™	Motion-SPM™	SuperSOT™-6	Ultra FRFET™
FACT®	OPTOLOGIC®	SuperSOT™-8	UniFET™
FAST®	OPTOPLANAR®	SupreMOS™	VOX™
FastvCore™	PDP SPM™	SyncFET™	VisualMax™
FlashWriter®*	Power-SPM™	 ®	XSTM
FPS™	PowerTrench®	The Power Franchise®	
F-PFS™	PowerXSTM		

\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, [www.fairchildsemi.com](http://www.fairchildsemi.com), under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

## PRODUCT STATUS DEFINITIONS

### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I39